Electronic Acknowledgement Receipt				
EFS ID:	1118563			
Application Number:	10604578			
Confirmation Number:	1577			
Title of Invention:	ENCAPSULATED PIN STRUCTURE FOR IMPROVED RELIABILIT OF WAFER			
First Named Inventor:	Tien-Jen Cheng			
Customer Number:	32074			
Filer:	H. Daniel Schnurmann			
Filer Authorized By:				
Attorney Docket Number:	FIS920030103US1			
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Time Stamp:	13:40:05			
Application Type:	Utility			
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	FIS920030103US1AMENDM ENT.pdf	509840	no	16

Warnings:					
Information:					
Total Files Size (in bytes):	509840				

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.